

LM1084 5A 低压降正稳压器

1 特性

- 提供 3.3V、5.0V 和可调节版本
- 电流限制和热保护
- 输出电流：5A
- 工业级温度范围：-40°C 至 125°C
- 线性调整率 0.015% (典型值)
- 负载调整率 0.1% (典型值)

2 应用

- 用于开关直流/直流转换器的后置稳压器
- 高效线性稳压器
- 电池充电器

3 说明

LM1084 是一款稳压器，在负载电流为 5A 时具有 1.5V 的最大压降。该器件具有与 TI 业内通用 LM317 相同的引脚排列。

需要使用两个电阻来设置 LM1084 可调节输出电压版本的输出电压。固定输出电压版本集成了调节电阻器。

LM1084 电路包含齐纳微调带隙基准、电流限制和热关断功能。

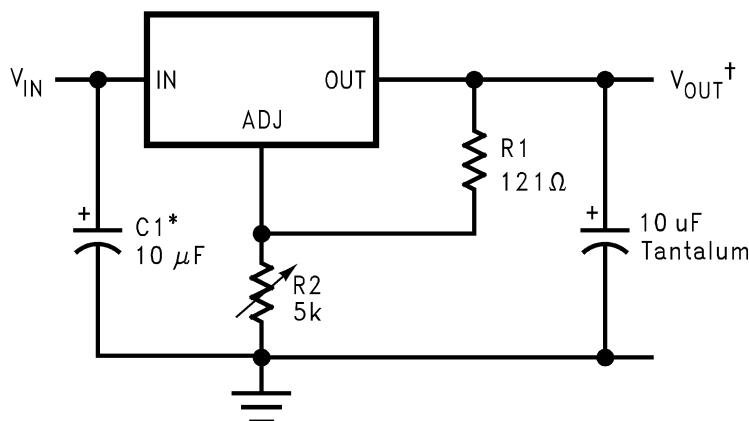
请参阅 LM1085 了解 3A 版本，参阅 LM1086 了解 1.5A 版本。

封装信息

器件型号	封装 ⁽¹⁾	封装尺寸 ⁽²⁾
LM1084	KTT (TO-263, 3)	10.16mm × 15.24mm
	NDE (TO-220, 3)	10.16mm × 4.58mm

(1) 如需更多信息，请参阅 [机械、封装和可订购信息](#)。

(2) 封装尺寸 (长 × 宽) 为标称值，并包括引脚 (如适用)。



*NEEDED IF DEVICE IS FAR FROM FILTER CAPACITORS

$$^{\dagger}V_{OUT} = 1.25V \left(1 + \frac{R2}{R1}\right)$$

典型应用



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4 Pin Configuration and Functions

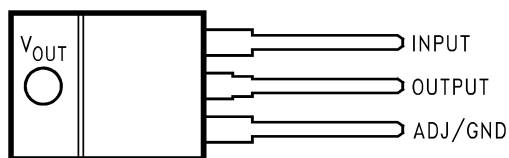


图 4-1. 3-Pin TO-220 Package Top View

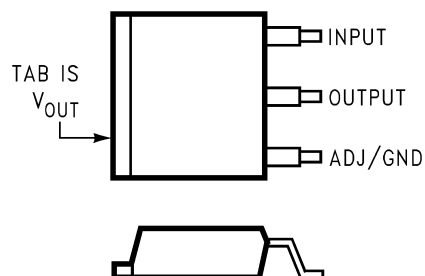


图 4-2. 3-Pin TO-263 Package Top View

表 4-1. Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
ADJ/GND	1	-	Adjust pin for the adjustable output voltage version. Ground pin for the fixed output voltage versions.
OUTPUT	2	O	Output voltage pin for the regulator.
INPUT	3	I	Input voltage pin for the regulator.

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)^{(1) (2)}

	MIN	MAX	UNIT
Maximum input to output voltage differential			
LM1084-ADJ		29	V
LM1084-3.3		27	V
LM1084-5.0		25	V
Power dissipation ⁽³⁾		Internally limited	
Junction temperature (T_J) ⁽⁴⁾		150	°C
Lead temperature		260, to 10 sec	°C
Storage temperature, T_{stg}	– 65	150	°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. The *Recommended Operating Conditions* indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the [Electrical Characteristics](#).
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) Power dissipation is kept in a safe range by current limiting circuitry. See the [Overload Recovery](#) section.
- (4) The maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(max)} - T_A) / \theta_{JA}$. All numbers apply for packages soldered directly into a PC board. See the [Thermal Considerations](#).

5.2 ESD Ratings

	VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

	MIN	MAX	UNIT
Junction temperature range (T_J) ⁽²⁾			
Control section	– 40	125	°C
Output section	– 40	150	°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. *Recommended Operating Conditions* indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the [Electrical Characteristics](#).
- (2) The maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(max)} - T_A) / \theta_{JA}$. All numbers apply for packages soldered directly into a PC board. Refer to [Thermal Considerations](#).

5.4 Thermal Information

THERMAL METRIC ⁽¹⁾		LM1084		UNIT
		KTT	NDE	
		3 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	40.4	22.7	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	42.6	15.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	23.0	4.1	°C/W
ψ_{JT}	Junction-to-top characterization parameter	9.8	2.1	°C/W
ψ_{JB}	Junction-to-board characterization parameter	22.0	4.1	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance: Control section/Output section	0.65/2.7	0.65/2.7	°C/W

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application note](#).

5.5 Electrical Characteristics

Typicals and limits apply for $T_J = 25^\circ\text{C}$ unless specified otherwise.

	PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
V_{REF}	Reference Voltage	LM1084-ADJ, $I_{OUT} = 10\text{ mA}$, $V_{IN} - V_{OUT} = 3\text{ V}$, $10\text{ mA} \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $1.5\text{ V} \leq (V_{IN} - V_{OUT}) \leq 25\text{ V}$ ⁽³⁾	1.238	1.250	1.262	V
		LM1084-ADJ, $I_{OUT} = 10\text{ mA}$, $V_{IN} - V_{OUT} = 3\text{ V}$, $10\text{ mA} \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $1.5\text{ V} \leq (V_{IN} - V_{OUT}) \leq 25\text{ V}$ ⁽³⁾ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	1.225	1.250	1.270	
V_{OUT}	Output Voltage ⁽³⁾	LM1084-3.3, $I_{OUT} = 0\text{ mA}$, $V_{IN} = 8\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $4.8\text{ V} \leq V_{IN} \leq 15\text{ V}$	3.270	3.300	3.330	V
		LM1084-3.3, $I_{OUT} = 0\text{ mA}$, $V_{IN} = 8\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $4.8\text{ V} \leq V_{IN} \leq 15\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	3.235	3.300	3.365	
		LM1084-5.0, $I_{OUT} = 0\text{ mA}$, $V_{IN} = 8\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $6.5\text{ V} \leq V_{IN} \leq 20\text{ V}$	4.950	5.000	5.050	V
		LM1084-5.0, $I_{OUT} = 0\text{ mA}$, $V_{IN} = 8\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $6.5\text{ V} \leq V_{IN} \leq 20\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	4.900	5.000	5.100	
ΔV_{OUT}	Line Regulation ⁽⁴⁾	LM1084-ADJ, $I_{OUT} = 10\text{ mA}$, $1.5\text{ V} \leq (V_{IN} - V_{OUT}) \leq 15\text{ V}$		0.015%	0.2%	
		LM1084-ADJ, $I_{OUT} = 10\text{ mA}$, $1.5\text{ V} \leq (V_{IN} - V_{OUT}) \leq 15\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		0.035%	0.2%	
		LM1084-3.3, $I_{OUT} = 0\text{ mA}$, $4.8\text{ V} \leq V_{IN} \leq 15\text{ V}$		0.5	6	mV
		LM1084-3.3, $I_{OUT} = 0\text{ mA}$, $4.8\text{ V} \leq V_{IN} \leq 15\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		1.0	6	
		LM1084-5.0, $I_{OUT} = 0\text{ mA}$, $6.5\text{ V} \leq V_{IN} \leq 20\text{ V}$		0.5	10	mV
		LM1084-5.0, $I_{OUT} = 0\text{ mA}$, $6.5\text{ V} \leq V_{IN} \leq 20\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		1.0	10	

5.5 Electrical Characteristics (续)

Typicals and limits apply for $T_J = 25^\circ\text{C}$ unless specified otherwise.

	PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
ΔV_{OUT}	Load Regulation ⁽⁴⁾	LM1084-ADJ, $(V_{IN} - V_{OUT}) = 3\text{ V}$, $10\text{ mA} \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$		0.1 %	0.3%	
		LM1084-ADJ, $(V_{IN} - V_{OUT}) = 3\text{ V}$, $10\text{ mA} \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		0.2%	0.4%	
		LM1084-3.3, $V_{IN} = 5\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$		3	15	mV
		LM1084-3.3, $V_{IN} = 5\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		7	20	
		LM1084-5.0, $V_{IN} = 8\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$		5	20	mV
		LM1084-5.0, $V_{IN} = 8\text{ V}$, $0 \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		10	35	
	Dropout Voltage ⁽⁵⁾	LM1084-ADJ, 3.3, 5, 12, ΔV_{REF} , $\Delta V_{OUT} = 1\%$, $I_{OUT} = 5\text{ A}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		1.3	1.5	V
I_{LIMIT}	Current Limit	LM1084-ADJ, $V_{IN} - V_{OUT} = 5\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	5.5	8.0		A
		LM1084-ADJ, $V_{IN} - V_{OUT} = 25\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	0.3	0.6		
		LM1084-3.3, $V_{IN} = 8\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	5.5	8.0		A
		LM1084-5.0, $V_{IN} = 10\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	5.5	8.0		A
	Minimum Load Current ⁽⁶⁾	LM1084-ADJ, $V_{IN} - V_{OUT} = 25\text{ V}$		5	10.0	mA
	Quiescent Current	LM1084-3.3, $V_{IN} = 18\text{ V}$		5.0	10.0	mA
		LM1084-5.0, $V_{IN} \leq 20\text{ V}$		5.0	10.0	mA
	Thermal Regulation	$T_A = 25^\circ\text{C}$, 30 ms Pulse		0.003	0.015	%/W
	Ripple Rejection	$f_{RIPPLE} = 120\text{ Hz}$, $C_{OUT} = 25\text{ }\mu\text{F}$ Tantalum, $I_{OUT} = 5\text{ A}$				dB
		LM1084-ADJ, $C_{ADJ} = 25\text{ }\mu\text{F}$, $(V_{IN} - V_O) = 3\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	60	75		
		LM1084-3.3, $V_{IN} = 6.3\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	60	72		dB
		LM1084-5.0, $V_{IN} = 8\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$	60	68		dB
	Adjust Pin Current	LM1084		55		μA
		LM1084, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$			120	
	Adjust Pin Current Change	$10\text{ mA} \leq I_{OUT} \leq I_{FULL\text{ LOAD}}$, $1.5\text{ V} \leq V_{IN} - V_{OUT} \leq 25\text{ V}$, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		0.2	5	μA
	Temperature Stability	$-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$		0.5%		
	Long Term Stability	$T_A = 125^\circ\text{C}$, 1000 Hrs		0.3%	1.0%	
	RMS Output Noise (% of V_{OUT})	$10\text{ Hz} \leq f \leq 10\text{ kHz}$		0.003%		

(1) All limits are specified by testing or statistical analysis.

(2) Typical Values represent the most likely parametric norm.

(3) $I_{FULLLOAD}$ is defined in the current limit curves. The $I_{FULLLOAD}$ Curve defines the current limit as a function of input-to-output voltage. Note that 30W power dissipation for the LM1084 is only achievable over a limited range of input-to-output voltage.

(4) Load and line regulation are measured at constant junction temperature, and are ensured up to the maximum power dissipation of 30W. Power dissipation is determined by the input/output differential and the output current. ensured maximum power dissipation will not be available over the full input/output range.

(5) Dropout voltage is specified over the full output current range of the device.

(6) The minimum output current required to maintain regulation.

5.6 Typical Characteristics

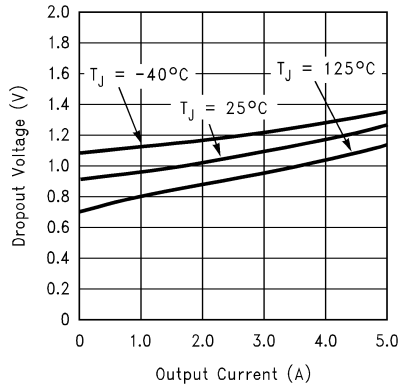


图 5-1. Dropout Voltage ($V_{IN}-V_{OUT}$)

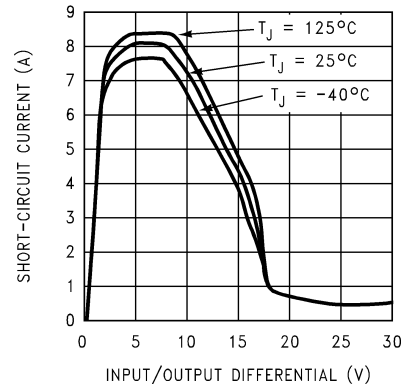


图 5-2. Short-Circuit Current

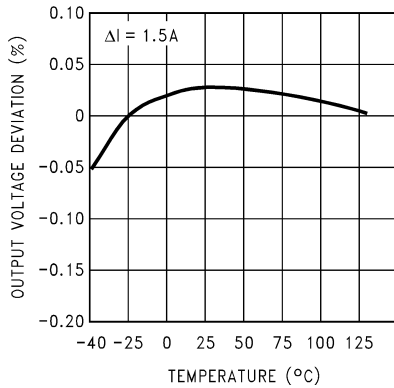


图 5-3. Load Regulation

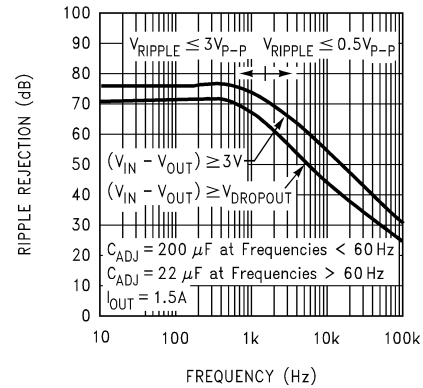


图 5-4. LM1084-ADJ Ripple Rejection

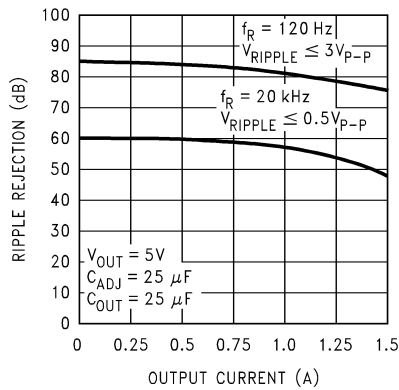


图 5-5. LM1084-ADJ Ripple Rejection vs Current

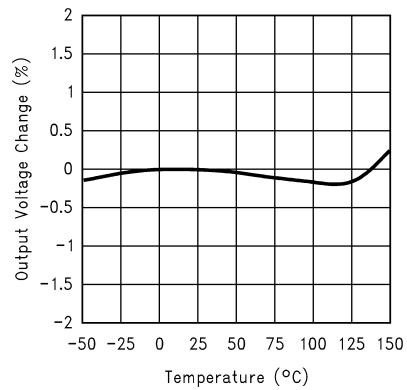


图 5-6. Temperature Stability

5.6 Typical Characteristics (continued)

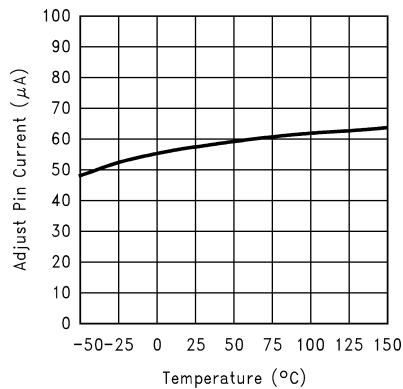


图 5-7. Adjust Pin Current

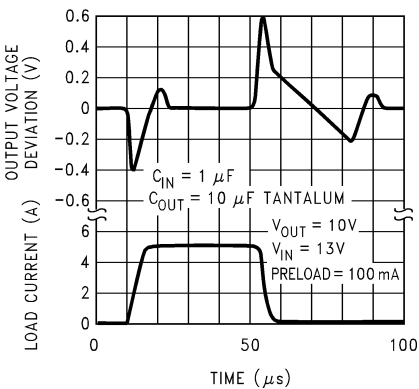


图 5-8. LM1084-ADJ Load Transient Response

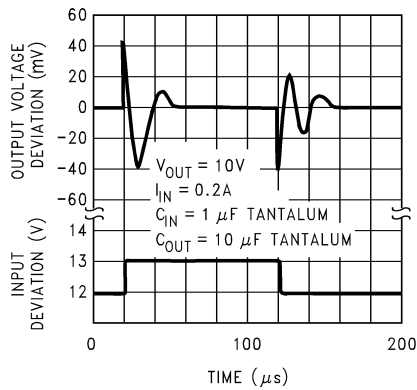


图 5-9. LM1084-ADJ Line Transient Response

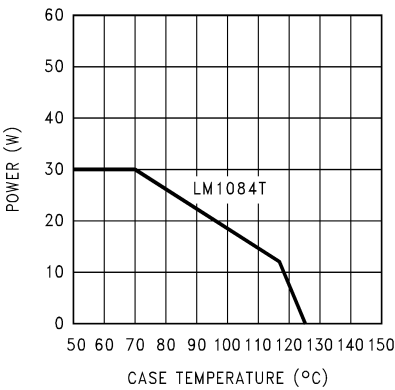


图 5-10. Maximum Power Dissipation

However, the adjustable version allows this degradation of ripple rejection to be compensated. The adjust terminal can be bypassed to ground with a capacitor (C_{ADJ}). The impedance of the C_{ADJ} should be equal to or less than R_1 at the desired ripple frequency. This bypass capacitor prevents ripple from being amplified as the output voltage is increased.

$$1/(2\pi \times f_{RIPPLE} \times C_{ADJ}) \leq R_1 \quad (1)$$

6.3.2 Load Regulation

The LM1084 regulates the voltage that appears between its output and ground pins, or between its output and adjust pins. In some cases, line resistances can introduce errors to the voltage across the load. To obtain the best load regulation, a few precautions are needed.

图 6-2 shows a typical application using a fixed output regulator. R_{t1} and R_{t2} are the line resistances. V_{LOAD} is less than the V_{OUT} by the sum of the voltage drops along the line resistances. In this case, the load regulation seen at the R_{LOAD} would be degraded from the data sheet specification. To improve this, the load should be tied directly to the output pin on the positive side and directly tied to the ground pin on the negative side.

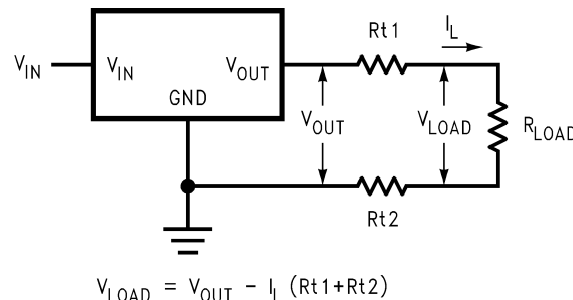


图 6-2. Typical Application Using Fixed Output Regulator

When the adjustable regulator is used (图 6-3), the best performance is obtained with the positive side of the resistor R_1 tied directly to the output pin of the regulator rather than near the load. This eliminates line drops from appearing effectively in series with the reference and degrading regulation. For example, a 5-V regulator with 0.05Ω resistance between the regulator and load will have a load regulation due to line resistance of $0.05\Omega \times I_L$. If $R_1 (= 125\Omega)$ is connected near the load the effective line resistance will be $0.05\Omega (1 + R_2/R_1)$ or in this case, it is 4 times worse. In addition, the ground side of the resistor R_2 can be returned near the ground of the load to provide remote ground sensing and improve load regulation.

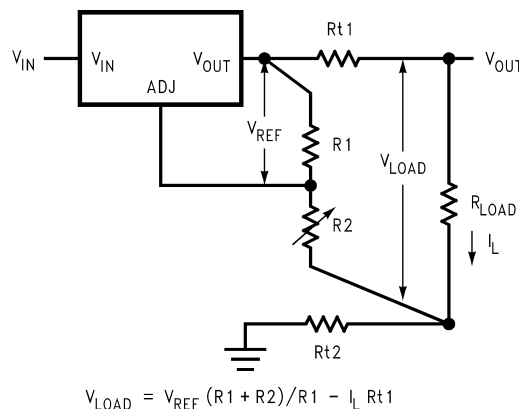


图 6-3. Best Load Regulation Using Adjustable Output Regulator

6.3.3 Overload Recovery

Overload recovery refers to regulator's ability to recover from a short circuited output. A key factor in the recovery process is the current limiting used to protect the output from drawing too much power. The current limiting circuit reduces the output current as the input to output differential increases. Refer to short circuit curve in the [Typical Characteristics](#) section.

During normal start-up, the input to output differential is small because the output follows the input. But, if the output is shorted, then the recovery involves a large input to output differential. Sometimes during this condition the current limiting circuit is slow in recovering. If the limited current is too low to develop a voltage at the output, the voltage will stabilize at a lower level. Under these conditions it may be necessary to recycle the power of the regulator in order to get the smaller differential voltage and thus adequate start up conditions. See the [Typical Characteristics](#) section for the short circuit current vs. input differential voltage.

6.4 Device Functional Modes

6.4.1 Output Voltage

The LM1084 adjustable version develops a 1.25-V reference voltage, (V_{REF}), between the output and the adjust pin. As shown in [图 6-4](#), this voltage is applied across resistor R1 to generate a constant current I1. This constant current then flows through R2. The resulting voltage drop across R2 adds to the reference voltage to sets the desired output voltage.

The current I_{ADJ} from the adjustment terminal introduces an output error. But because it is small (120 μ A max), it becomes negligible when R1 is in the 100 Ω range.

For fixed voltage devices, R1 and R2 are integrated inside the devices.

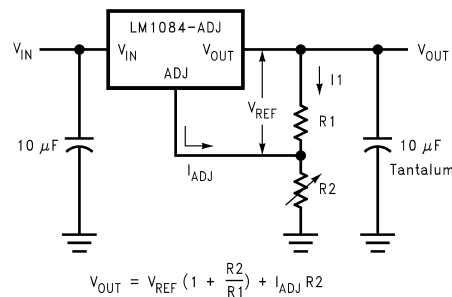


图 6-4. Basic Adjustable Regulator

6.4.2 Stability Consideration

Stability consideration primarily concerns the phase response of the feedback loop. In order for stable operation, the loop must maintain negative feedback. The LM1084 requires a certain amount series resistance with capacitive loads. This series resistance introduces a zero within the loop to increase phase margin and thus increase stability. The equivalent series resistance (ESR) of solid tantalum or aluminum electrolytic capacitors is used to provide the appropriate zero (approximately 500 kHz).

Aluminum electrolytics are less expensive than tantalums, but their ESR varies exponentially at cold temperatures; therefore requiring close examination when choosing the desired transient response over temperature. Tantalums are a convenient choice because their ESR varies less than 2:1 over temperature.

The recommended load, decoupling capacitance is a 10- μ F tantalum or a 50- μ F aluminum. These values assure stability for the majority of applications.

The adjustable versions allow an additional capacitor to be used at the ADJ pin to increase ripple rejection. If this is done the output capacitor should be increased to 22 μ F for tantalum or to 150 μ F for aluminum.

Capacitors other than tantalum or aluminum can be used at the adjust pin and the input pin. A 10- μ F capacitor is a reasonable value at the input. See the [Ripple Rejection](#) section regarding the value for the adjust pin capacitor.

It is desirable to have large output capacitance for applications that entail large changes in load current (microprocessors for example). The higher the capacitance, the larger the available charge per demand. It is also desirable to provide low ESR to reduce the change in output voltage:

$$\Delta V = \Delta I \times \text{ESR} \quad (2)$$

It is common practice to use several tantalum and ceramic capacitors in parallel to reduce this change in the output voltage by reducing the overall ESR.

Output capacitance can be increased indefinitely to improve transient response and stability.

6.4.3 Protection Diodes

Under normal operation, the LM1084 regulator does not need any protection diode. With the adjustable device, the internal resistance between the adjustment and output terminals limits the current. No diode is needed to divert the current around the regulator even with a capacitor on the adjustment pin. The adjust pin can take a transient signal of ± 25 V with respect to the output voltage without damaging the device.

When an output capacitor is connected to a regulator and the input is shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage of the regulator, and rate of decrease of V_{IN} . In the LM1084 regulator, the internal diode between the output and input pins can withstand microsecond surge currents of 10A to 20A. With an extremely large output capacitor ($\geq 1000 \mu\text{f}$), and with input instantaneously shorted to ground, the regulator could be damaged. In this case, an external diode is recommended between the output and input pins to protect the regulator, shown in [图 6-5](#).

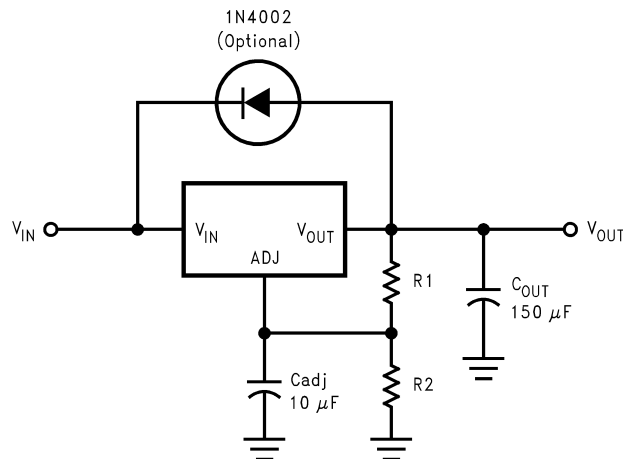


图 6-5. Regulator with Protection Diode

7 Application and Implementation

备注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

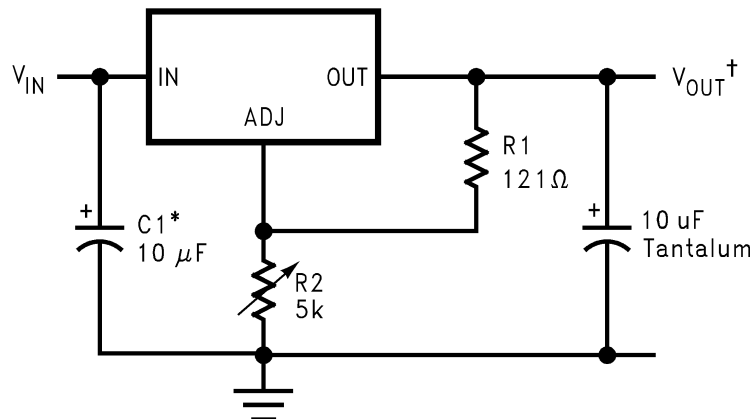
7.1 Application Information

The LM1084 is versatile in its applications, including uses in programmable output regulation and local on-card regulation. Or, by connecting a fixed resistor between the ADJUST and OUTPUT terminals, the LM1084 can function as a precision current regulator. An optional output capacitor can be added to improve transient response. The ADJUST terminal can be bypassed to achieve very high ripple-rejection ratios, which are difficult to achieve with standard three-terminal regulators. Please note, in the following applications, if ADJ is mentioned, it makes use of the adjustable version of the part, however, if GND is mentioned, it is the fixed voltage version of the part.

7.2 Typical Applications

7.2.1 1.2-V to 15-V Adjustable Regulator

This part can be used as a simple low drop out regulator to enable a variety of output voltages needed for demanding applications. By using an adjustable R2 resistor a variety of output voltages can be made possible as shown in 图 7-1 based on the LM1084-ADJ.



*NEEDED IF DEVICE IS FAR FROM FILTER CAPACITORS

$$^{\dagger}V_{OUT} = 1.25V \left(1 + \frac{R2}{R1}\right)$$

图 7-1. 1.2-V to 15-V Adjustable Regulator

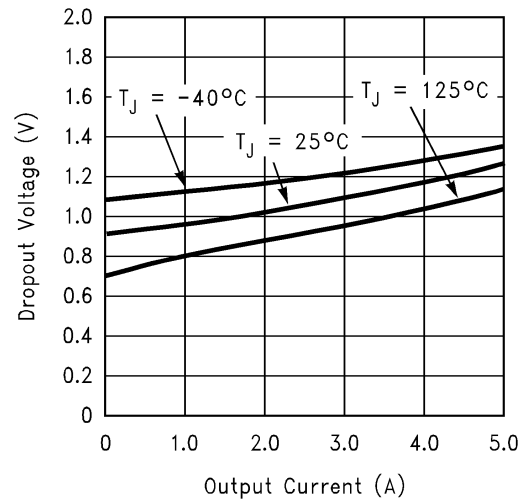
7.2.1.1 Design Requirements

The device component count is very minimal, employing two resistors as part of a voltage divider circuit and an output capacitor for load regulation.

7.2.1.2 Detailed Design Procedure

The voltage divider for this part is set based on the equation shown in 图 7-1, where R1 is the upper feedback resistor and R2 is the lower feedback resistor.

7.2.1.3 Application Curve



7.2.2 Adjustable at 5 V

The application shown in [图 7-2](#) outlines a simple 5 V output application made possible by the LM1084-ADJ. This application can provide 5 A at high efficiencies and very low drop-out.

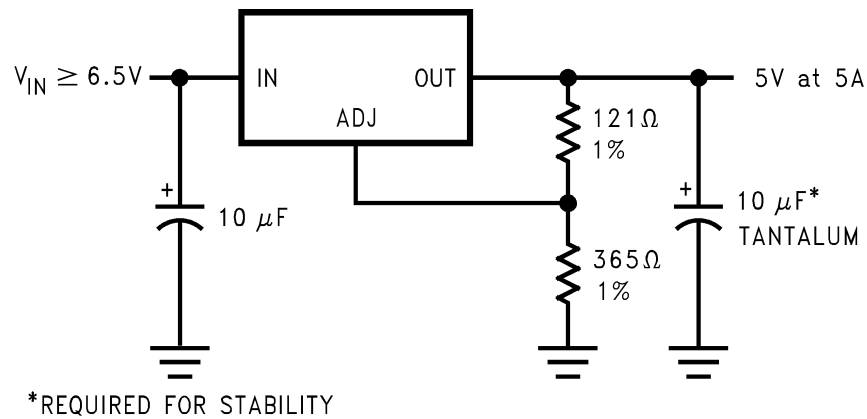


图 7-2. Adjustable @ 5 V

7.2.3 5-V Regulator With Shutdown

A variation of the 5 V output regulator application with shutdown control is shown in 图 7-3 based on the LM1084-ADJ. It uses a simple NPN transistor on the ADJ pin to block or sink the current on the ADJ pin. If the TTL logic is pulled high, the NPN transistor is activated and the part is disabled, outputting approximately 1.25 V. If the TTL logic is pulled low, the NPN transistor is unbiased and the regulator functions normally.

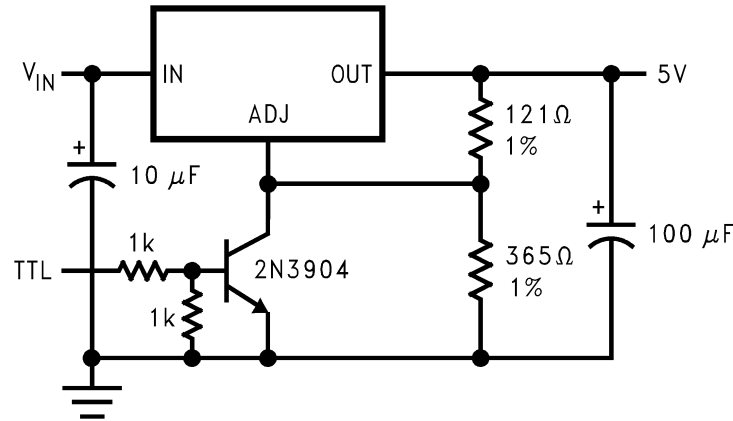


图 7-3. 5-V Regulator with Shutdown

7.2.4 Battery Charger

The LM1084-ADJ can be used as a battery charger to regulate the charging current required by the battery bank as shown in 图 7-4. In this application the LM1084 acts as a constant voltage, constant current part by sensing the voltage potential across the battery and compensating it to the current voltage. To maintain this voltage, the regulator delivers the maximum charging current required to charge the battery. As the battery approaches the fully charged state, the potential drop across the sense resistor, R_S , reduces and the regulator throttles back the current to maintain the float voltage of the battery.

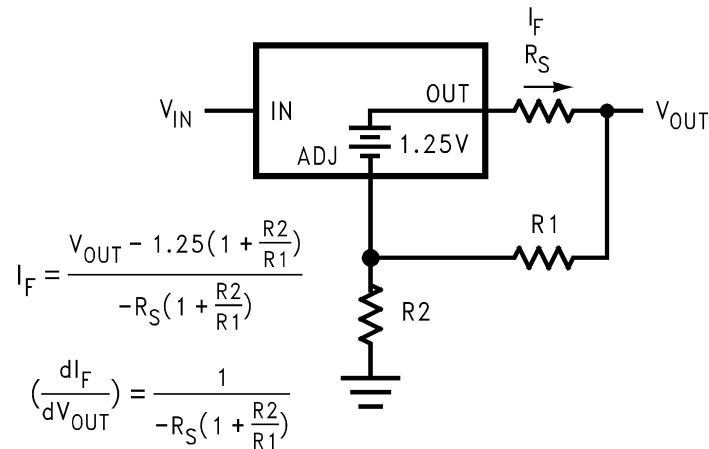
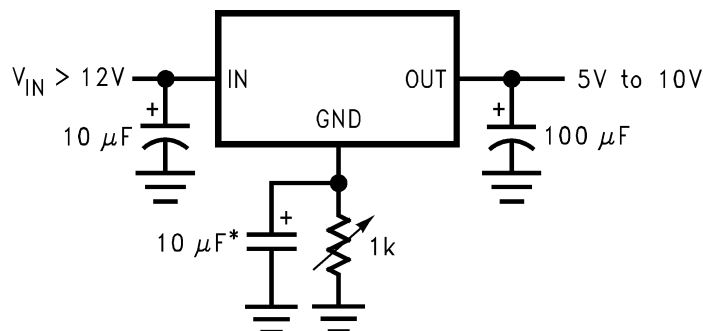


图 7-4. Battery Charger

7.2.5 Adjustable Fixed Regulator

A simple adjustable, fixed range output regulator can be made possible by placing a variable resistor on the ground of the device as shown in 图 7-5 based on the fixed output voltage LM1084-5.0. The GND pin has a small quiescent current of 5 mA typical. Increasing the resistance on the GND pin increases the voltage potential across the resistor. This potential is then mirrored on to the output to increase the total output voltage by the potential drop across the GND resistor.



*OPTIONAL IMPROVES RIPPLE REJECTION

图 7-5. Adjustable Fixed Regulator

7.2.6 Regulator with Reference

A fixed output voltage version of the LM1084-5.0 can be employed to provide an output rail and a reference rail at the same time as shown in 图 7-6. This simple application makes use of a reference diode, the LM136-5, to regulate the GND voltage to a fixed 5 V based on the quiescent current generated by the GND pin. This voltage is then added onto the output to generate a total of 10 V out.

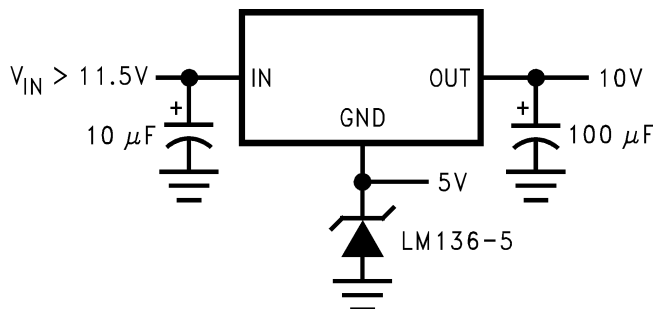


图 7-6. Regulator with Reference

7.2.7 High Current Lamp Driver Protection

A simple constant current source with protection can be designed by controlling the impedance between the lamp and ground. The LM1084-ADJ shown in 图 7-7 makes use of an external TTL or CMOS input to drive the NPN transistor. This pulls the output of the regulator to a few tenths of a volt and puts the part into current limit. Releasing the logic will reduce the current flow across the lamp into the normal operating current thereby protecting the lamp during startup.

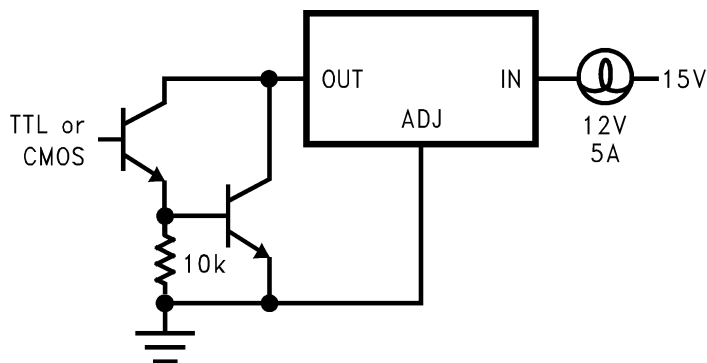


图 7-7. High Current Lamp Driver Protection

7.2.8 Battery Backup Regulated Supply

A regulated battery backup supply can be generated by using two fixed output voltage versions of the part as shown in 图 7-8. The top regulator supplies the Line voltage during normal operation, however when the input is not available, the second regulator derives power from the battery backup and regulates it to 5 V based on the LM1084-5.0. The diodes prevent the rails from back feeding into the supply and batteries.

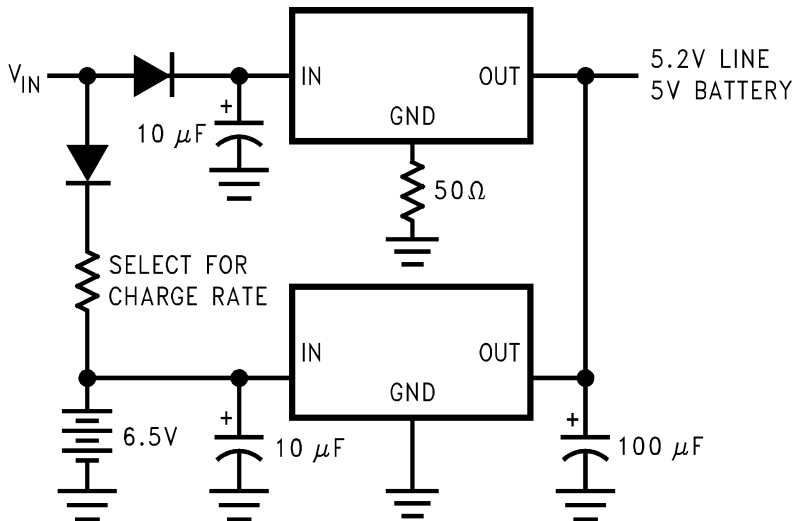
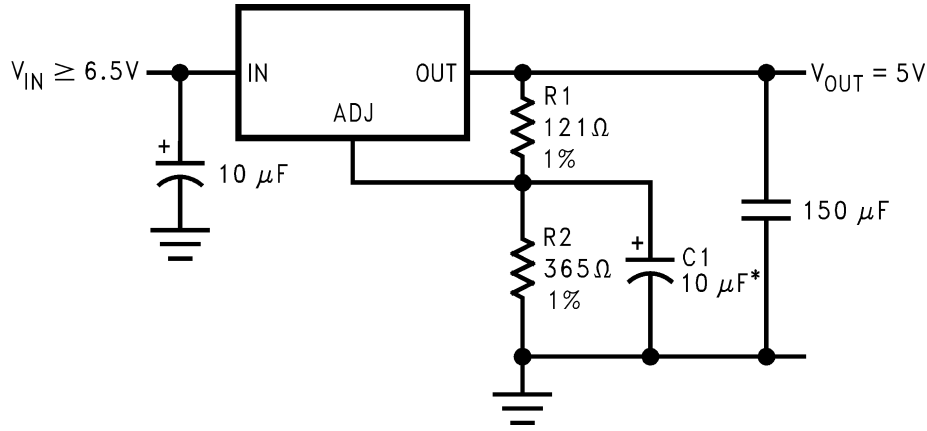


图 7-8. Battery Backup Regulated Supply

7.2.9 Ripple Rejection Enhancement

A very simple ripple rejection circuit is shown in 图 7-9 using the LM1084-ADJ. The capacitor C1 smooths out the ripple on the output by cleaning up the feedback path and preventing excess noise from feeding back into the regulator. Please remember X_{C1} should be approximately equal to R1 at the ripple frequency.



*C1 IMPROVES RIPPLE REJECTION.
 X_C SHOULD BE $\approx R1$ AT RIPPLE FREQUENCY

图 7-9. Ripple Rejection Enhancement

7.2.10 Automatic Light Control

A common street light control or automatic light control circuit is designed in 图 7-10 based on the LM1084-ADJ. The photo transistor conducts in the presence of light and grounds the ADJ pin preventing the lamp from turning on. However, in the absence of light, the LM1084 regulates the voltage to 1.25V between OUT and ADJ, ensuring the lamp remains on.

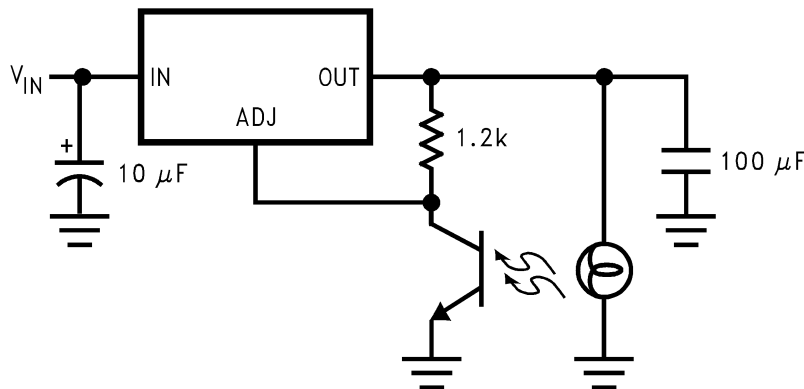


图 7-10. Automatic Light Control

7.2.11 Generating Negative Supply Voltage

A quick inverting output rail or negative output rail is shown in 图 7-11 using the LM1084 fixed output part. By tying the output to GND, the GND node is at a relatively more negative potential than the output. This is then interfaced to the negative application such as an operational amplifier or any other rail needing negative voltage.

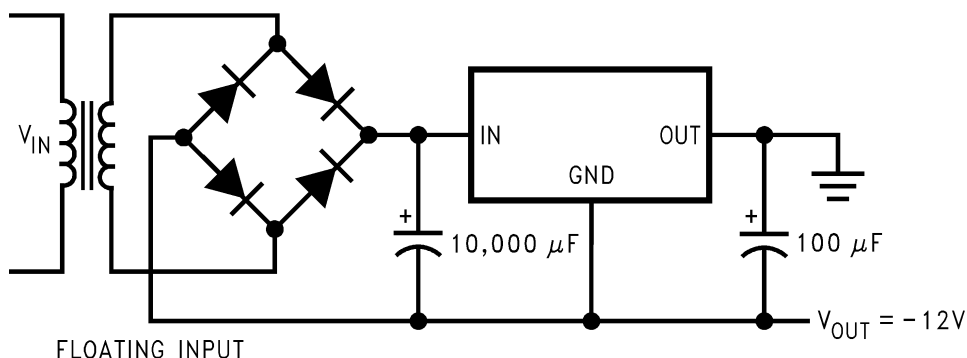


图 7-11. Generating Negative Supply Voltage

7.2.12 Remote Sensing

Remote sensing is a method of compensating the output voltage to a very precise degree by sensing the output and feeding it back through the feedback. The circuit implementing this is shown in [图 7-12](#) using the LM1084-ADJ. The output of the regulator is fed into a voltage follower to avoid any loading effects and the output of the op-amp is injected into the top of the feedback resistor network. This has the effect of modulating the voltage to a precise degree without additional loading on the output.

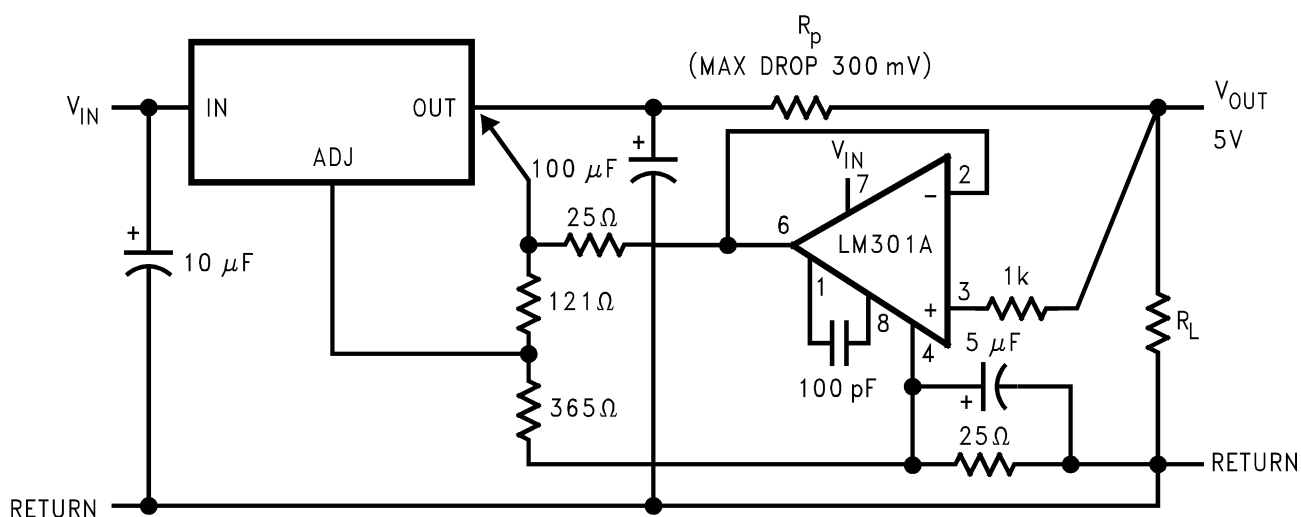


图 7-12. Remote Sensing

7.3 Power Supply Recommendations

The linear regulator input supply should be well regulated and kept at a voltage level such that the maximum input to output voltage differential allowed by the device is not exceeded. The minimum dropout voltage ($V_{IN} - V_{OUT}$) should be met with extra headroom when possible in order to keep the output well regulated. A 10 μ F or higher capacitor should be placed at the input to bypass noise.

7.4 Layout

7.4.1 Layout Guidelines

For the best overall performance, some layout guidelines should be followed. Place all circuit components on the same side of the circuit board and as near as practical to the respective linear regulator pins. Traces should be kept short and wide to reduce the amount of parasitic elements into the system. The actual width and thickness of traces will depend on the current carrying capability and heat dissipation required by the end system. An array of plated vias can be placed on the pad area underneath the TAB to conduct heat to any inner plane areas or to a bottom-side copper plane.

7.4.1.1 Thermal Considerations

ICs heats up when in operation, and power consumption is one factor in how hot it gets. The other factor is how well the heat is dissipated. Heat dissipation is predictable by knowing the thermal resistance between the IC and ambient (θ_{JA}). Thermal resistance has units of temperature per power (C/W). The higher the thermal resistance, the hotter the IC.

The LM1084 specifies the thermal resistance for each package as junction to case (θ_{JC}). In order to get the total resistance to ambient (θ_{JA}), two other thermal resistance must be added, one for case to heat-sink (θ_{CH}) and one for heatsink to ambient (θ_{HA}). The junction temperature can be predicted as follows:

$$T_J = T_A + P_D (\theta_{JC} + \theta_{CH} + \theta_{HA}) = T_A + P_D \theta_{JA} \quad (3)$$

T_J is junction temperature, T_A is ambient temperature, and P_D is the power consumption of the device. Device power consumption is calculated as follows:

$$I_{IN} = I_L + I_G \quad (4)$$

$$P_D = (V_{IN} - V_{OUT}) I_L + V_{IN} I_G \quad (5)$$

图 7-13 shows the voltages and currents which are present in the circuit.

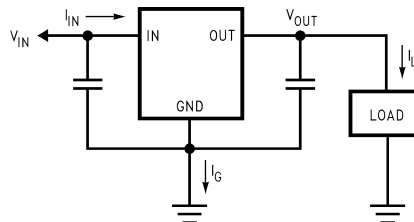


图 7-13. Power Dissipation Diagram

Once the devices power is determined, the maximum allowable ($\theta_{JA(max)}$) is calculated as:

$$\theta_{JA(max)} = T_{R(max)}/P_D = T_{J(max)} - T_{A(max)}/P_D \quad (6)$$

The LM1084 has different temperature specifications for two different sections of the IC: the control section and the output section. The [Thermal Information](#) table shows the junction to case thermal resistances for each of these sections, while the maximum junction temperatures ($T_{J(max)}$) for each section is listed in the [Absolute Maximum Ratings](#) table. $T_{J(max)}$ is 125°C for the control section, while $T_{J(max)}$ is 150°C for the output section.

$\theta_{JA(max)}$ should be calculated separately for each section as follows:

$$\theta_{JA(max, CONTROL SECTION)} = (125^\circ\text{C} - T_{A(max)})/P_D \quad (7)$$

$$\theta_{JA(max, OUTPUT SECTION)} = (150^\circ\text{C} - T_{A(max)})/P_D \quad (8)$$

The required heat sink is determined by calculating its required thermal resistance ($\theta_{HA(max)}$).

$$\theta_{HA(max)} = \theta_{JA(max)} - (\theta_{JC} + \theta_{CH}) \quad (9)$$

($\theta_{HA(max)}$) should also be calculated twice as follows:

$$(\theta_{HA(max)}) = \theta_{JA(max, CONTROL SECTION)} - (\theta_{JC (CONTROL SECTION)} + \theta_{CH}) \quad (10)$$

$$(\theta_{HA(max)}) = \theta_{JA(max, OUTPUT SECTION)} - (\theta_{JC (OUTPUT SECTION)} + \theta_{CH}) \quad (11)$$

If thermal compound is used, θ_{CH} can be estimated at 0.2 C/W. If the case is soldered to the heat sink, then a θ_{CH} can be estimated as 0 C/W.

After, $\theta_{HA(max)}$ is calculated for each section, choose the lower of the two $\theta_{HA(max)}$ values to determine the appropriate heat sink.

If PC board copper is going to be used as a heat sink, then 图 7-14 can be used to determine the appropriate area (size) of copper foil required.

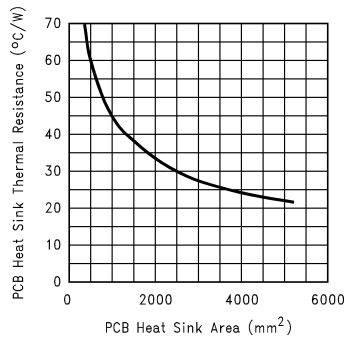


图 7-14. Heat Sink Thermal Resistance vs Area

7.4.2 Layout Example

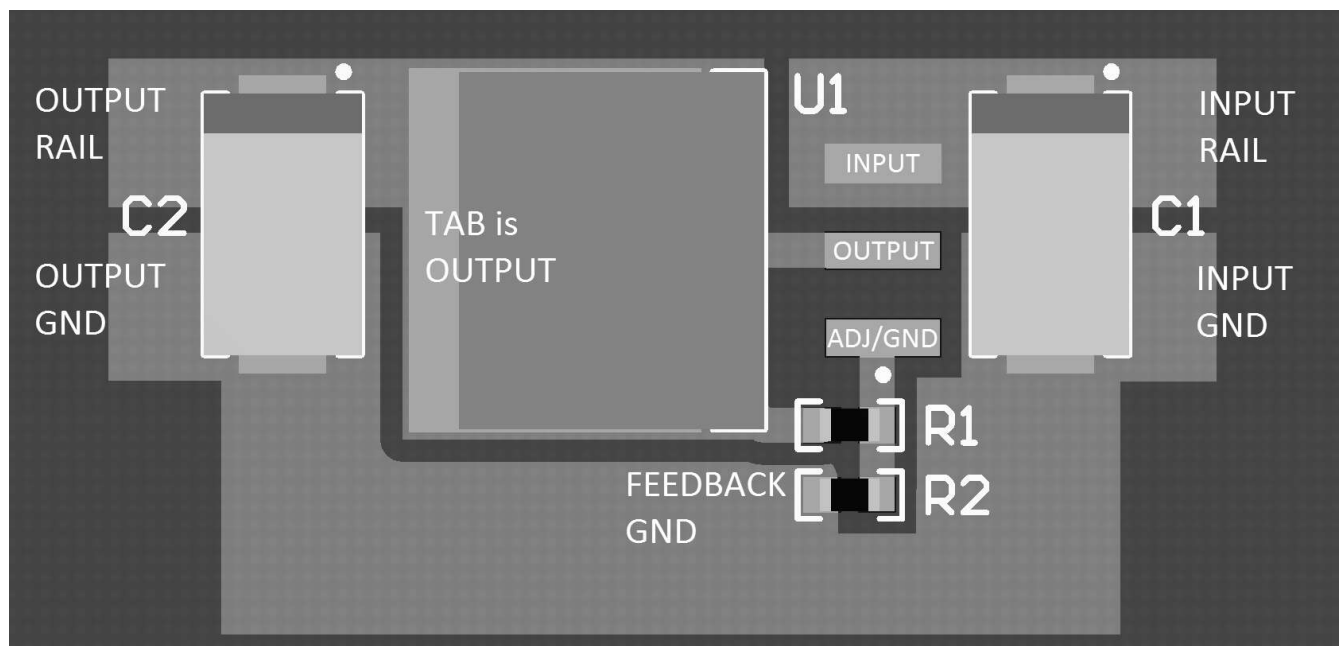


图 7-15. Layout Example

8 Device and Documentation Support

8.1 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](https://www.ti.com) 上的器件产品文件夹。点击 [通知](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

8.2 支持资源

[TI E2E™ 中文支持论坛](#) 是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [使用条款](#)。

8.3 Trademarks

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ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

8.5 术语表

TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

9 Revision History

注：以前版本的页码可能与当前版本的页码不同

Changes from Revision G (January 2015) to Revision H (March 2024)	Page
• 更新了整个文档中的表格、图和交叉参考的编号格式.....	1
• Changed output deviation voltage units in <i>LM1084-ADJ Line Transient Response</i> figure from V to mV.....	7
• Changed diode configuration in <i>Generating Negative Supply Voltage</i> figure.....	19

Changes from Revision F (March 2013) to Revision G (January 2015)	Page
• 添加了 引脚配置和功能 部分、ESD 等级表、特性说明 部分、器件功能模式、应用和实施 部分、电源相关建议 部分、布局 部分、器件和文档支持 部分以及 机械、封装和可订购信息 部分.....	1

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM1084IS-3.3/NOPB	Active	Production	DDPAK/ TO-263 (KTT) 3	45 TUBE	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-3.3
LM1084IS-3.3/NOPB.B	Active	Production	DDPAK/ TO-263 (KTT) 3	45 TUBE	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-3.3
LM1084IS-5.0/NOPB	Active	Production	DDPAK/ TO-263 (KTT) 3	45 TUBE	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-5.0
LM1084IS-5.0/NOPB.B	Active	Production	DDPAK/ TO-263 (KTT) 3	45 TUBE	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-5.0
LM1084IS-ADJ/NOPB	Active	Production	DDPAK/ TO-263 (KTT) 3	45 TUBE	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-ADJ
LM1084IS-ADJ/NOPB.B	Active	Production	DDPAK/ TO-263 (KTT) 3	45 TUBE	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-ADJ
LM1084ISX-3.3/NOPB	Active	Production	DDPAK/ TO-263 (KTT) 3	500 LARGE T&R	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-3.3
LM1084ISX-3.3/NOPB.B	Active	Production	DDPAK/ TO-263 (KTT) 3	500 LARGE T&R	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-3.3
LM1084ISX-5.0/NOPB	Active	Production	DDPAK/ TO-263 (KTT) 3	500 LARGE T&R	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-5.0
LM1084ISX-5.0/NOPB.B	Active	Production	DDPAK/ TO-263 (KTT) 3	500 LARGE T&R	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-5.0
LM1084ISX-ADJ/NOPB	Active	Production	DDPAK/ TO-263 (KTT) 3	500 LARGE T&R	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-ADJ
LM1084ISX-ADJ/NOPB.B	Active	Production	DDPAK/ TO-263 (KTT) 3	500 LARGE T&R	ROHS Exempt	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-ADJ
LM1084IT-3.3/NOPB	Active	Production	TO-220 (NDE) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-3.3
LM1084IT-3.3/NOPB.B	Active	Production	TO-220 (NDE) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-3.3
LM1084IT-5.0/NOPB	Active	Production	TO-220 (NDE) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-5.0
LM1084IT-5.0/NOPB.B	Active	Production	TO-220 (NDE) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-5.0

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM1084IT-ADJ/NOPB	Active	Production	TO-220 (NDE) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-ADJ
LM1084IT-ADJ/NOPB.B	Active	Production	TO-220 (NDE) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-ADJ

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

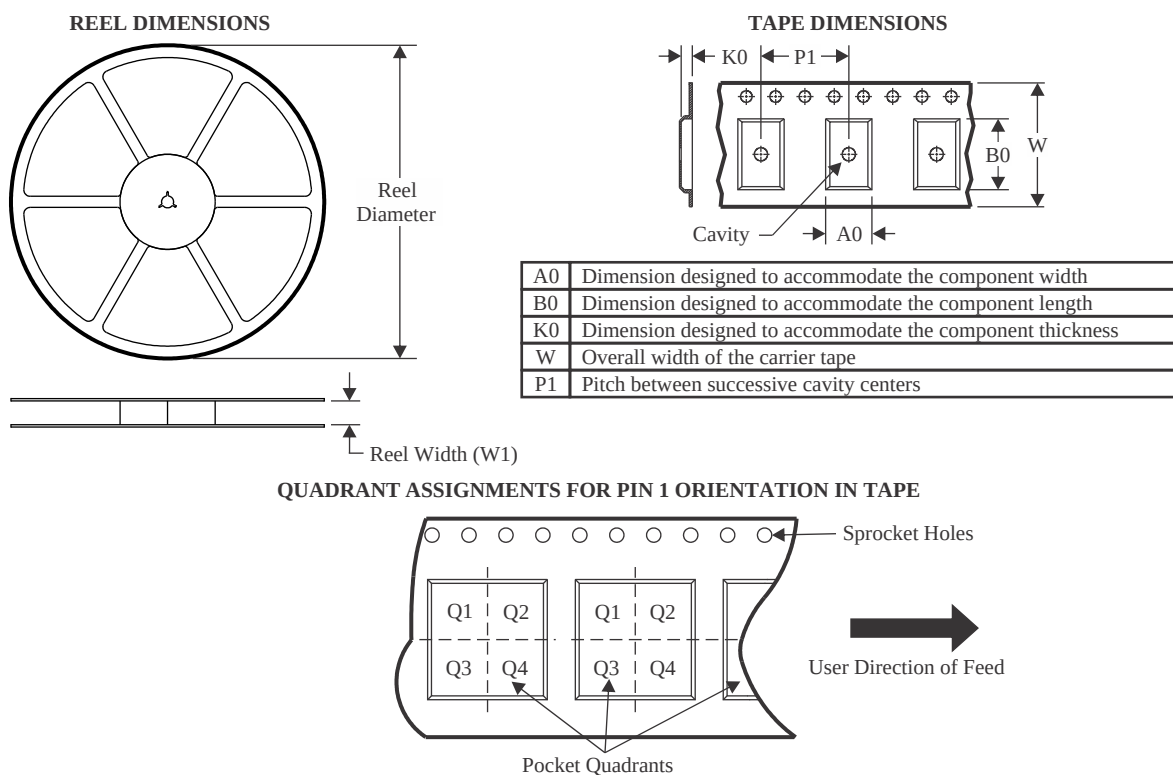
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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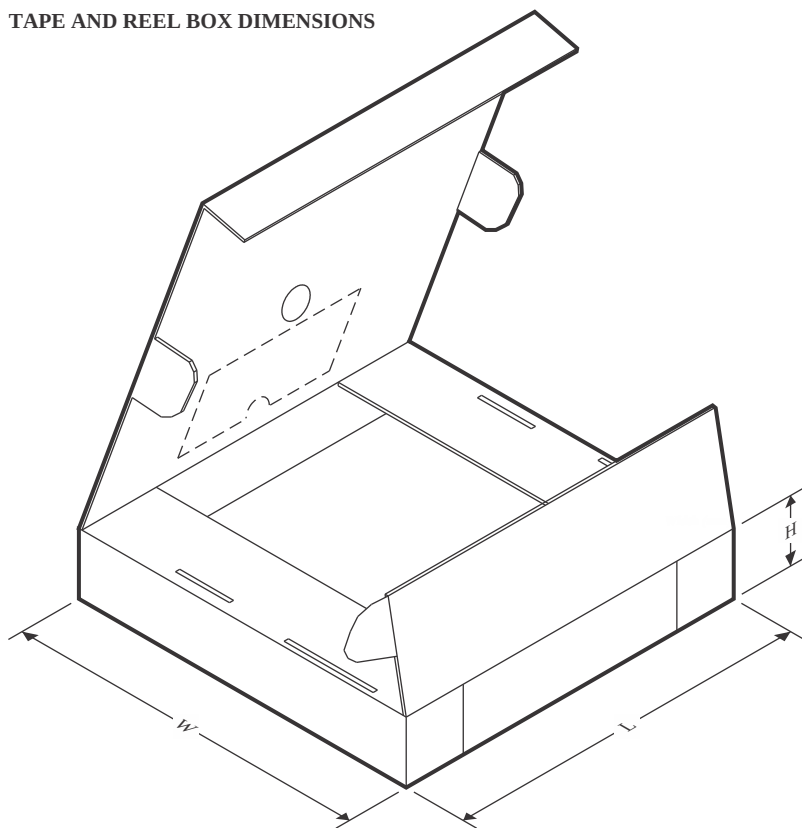
TAPE AND REEL INFORMATION



*All dimensions are nominal

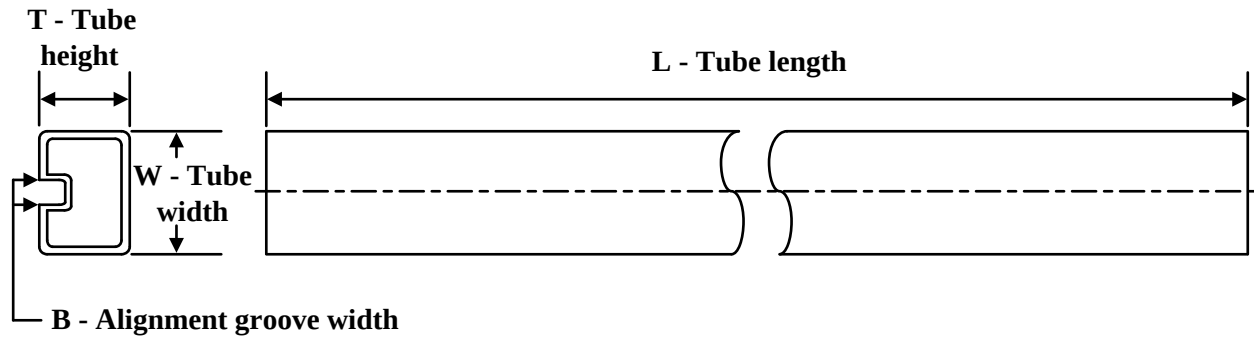
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM1084ISX-3.3/NOPB	DDPAK/TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM1084ISX-5.0/NOPB	DDPAK/TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM1084ISX-ADJ/NOPB	DDPAK/TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

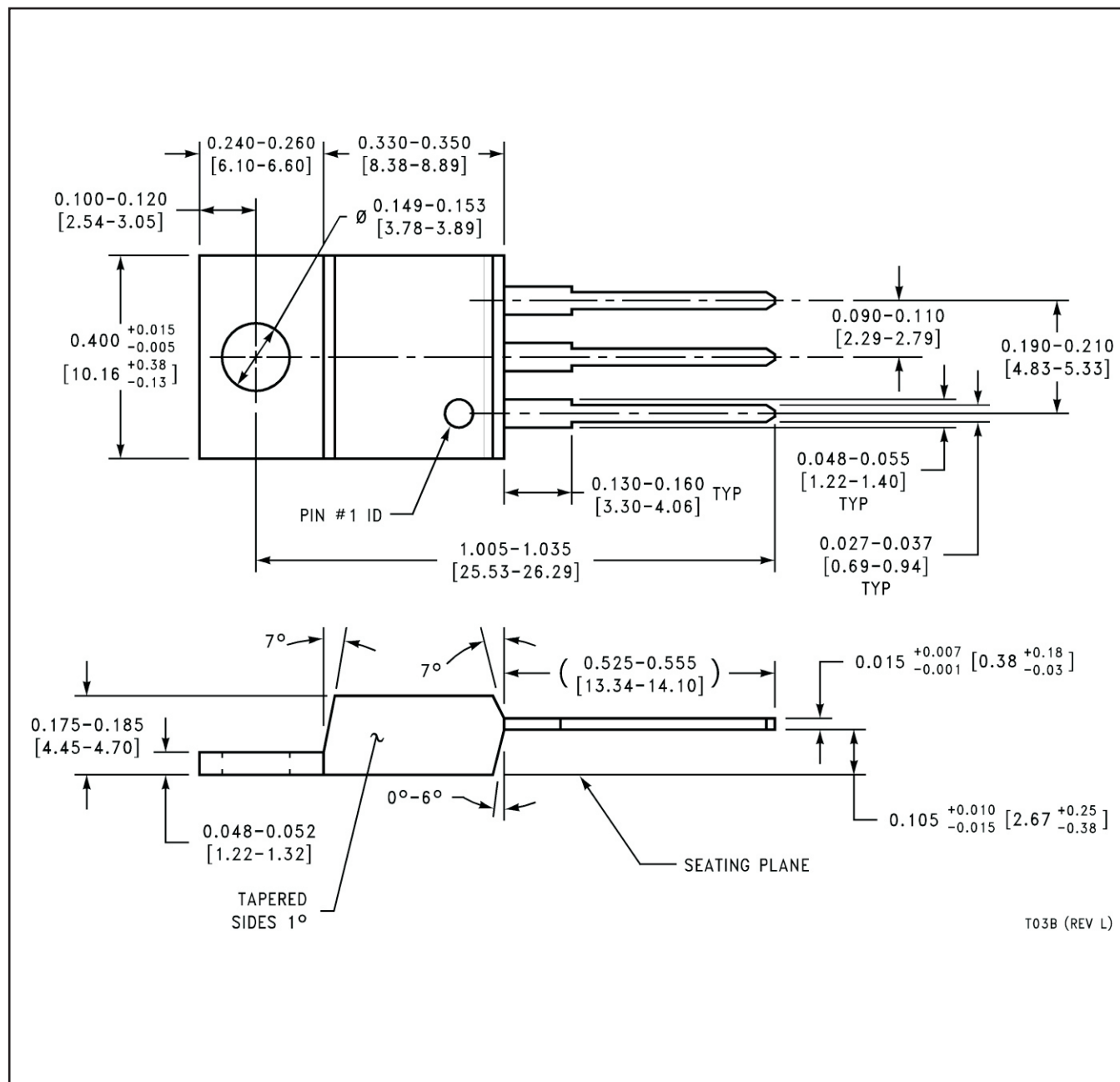
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM1084ISX-3.3/NOPB	DDPAK/TO-263	KTT	3	500	356.0	356.0	45.0
LM1084ISX-5.0/NOPB	DDPAK/TO-263	KTT	3	500	356.0	356.0	45.0
LM1084ISX-ADJ/NOPB	DDPAK/TO-263	KTT	3	500	356.0	356.0	45.0

TUBE


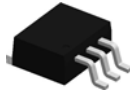
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
LM1084IS-3.3/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM1084IS-3.3/NOPB.B	KTT	TO-263	3	45	502	25	8204.2	9.19
LM1084IS-5.0/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM1084IS-5.0/NOPB.B	KTT	TO-263	3	45	502	25	8204.2	9.19
LM1084IS-ADJ/NOPB	KTT	TO-263	3	45	502	25	8204.2	9.19
LM1084IS-ADJ/NOPB.B	KTT	TO-263	3	45	502	25	8204.2	9.19
LM1084IT-3.3/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM1084IT-3.3/NOPB.B	NDE	TO-220	3	45	502	33	6985	4.06
LM1084IT-5.0/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM1084IT-5.0/NOPB.B	NDE	TO-220	3	45	502	33	6985	4.06
LM1084IT-ADJ/NOPB	NDE	TO-220	3	45	502	33	6985	4.06
LM1084IT-ADJ/NOPB.B	NDE	TO-220	3	45	502	33	6985	4.06

NDE0003B



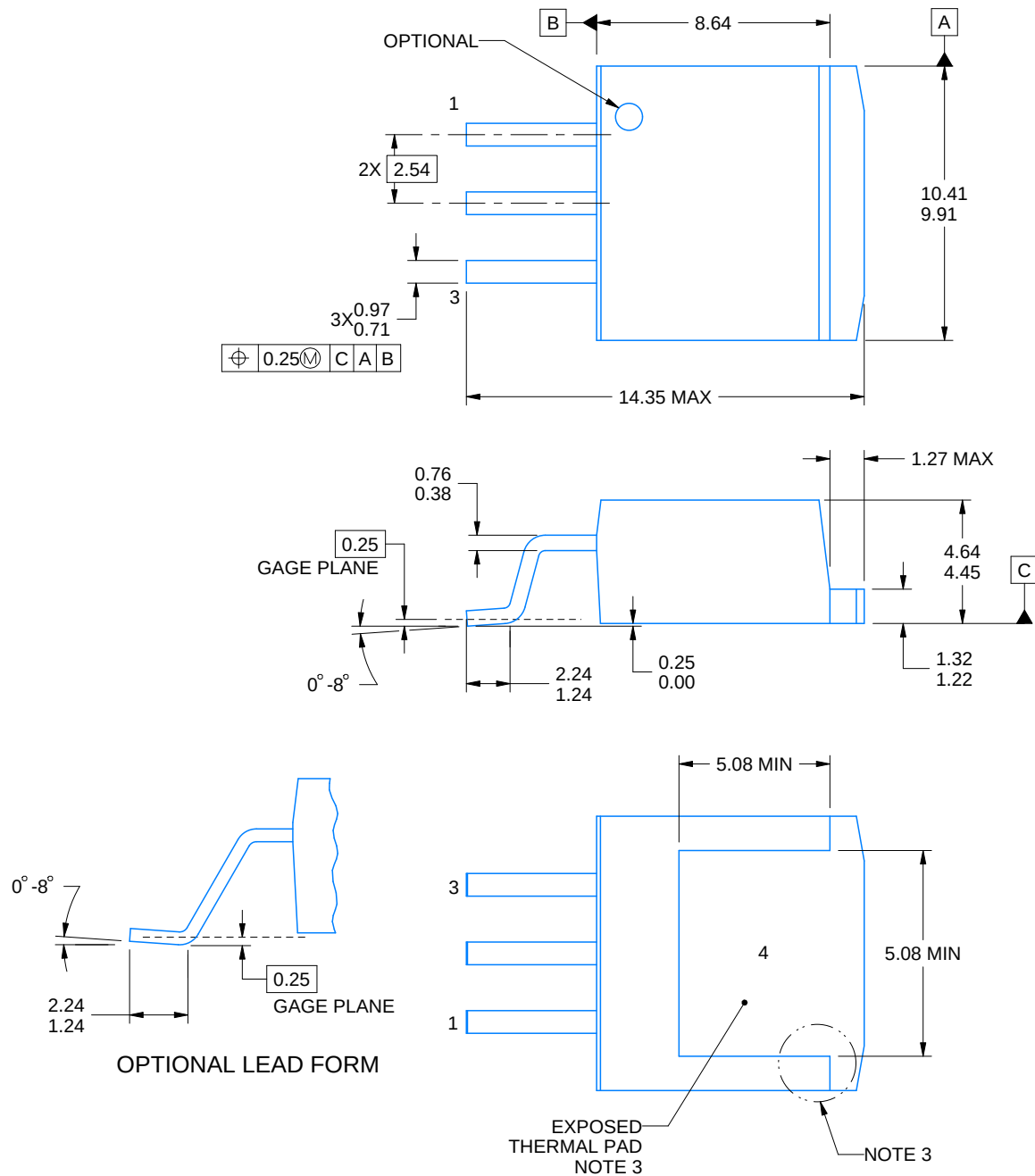
KTT0003B



PACKAGE OUTLINE

TO-263 - 4.83 mm max height

TRANSISTOR OUTLINE



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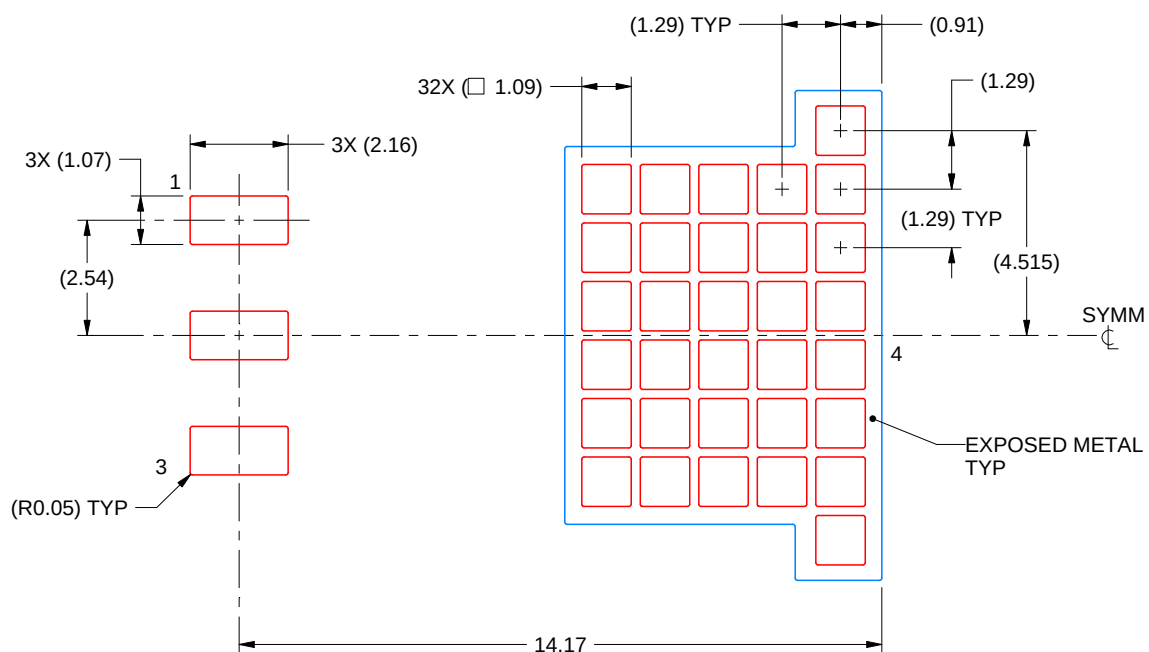
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Features may not exist and shape may vary per different assembly sites.
4. Reference JEDEC registration TO-263, except minimum lead thickness and minimum exposed pad length.

KT0003B

TO-263 - 4.83 mm max height

TRANSISTOR OUTLINE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD
60% PRINTED SOLDER COVERAGE BY AREA
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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